

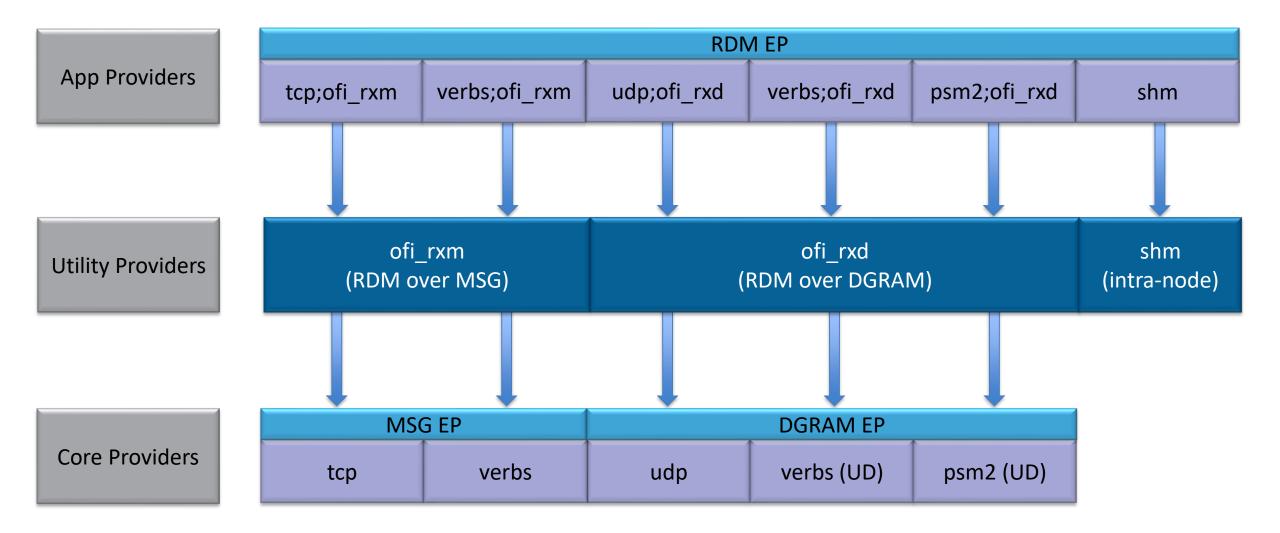
15th ANNUAL WORKSHOP 2019

AN OVERVIEW OF OFI UTILITY PROVIDERS: IMPLEMENTATION AND USES

Alexia Ingerson
Intel ® Corporation

March 2019

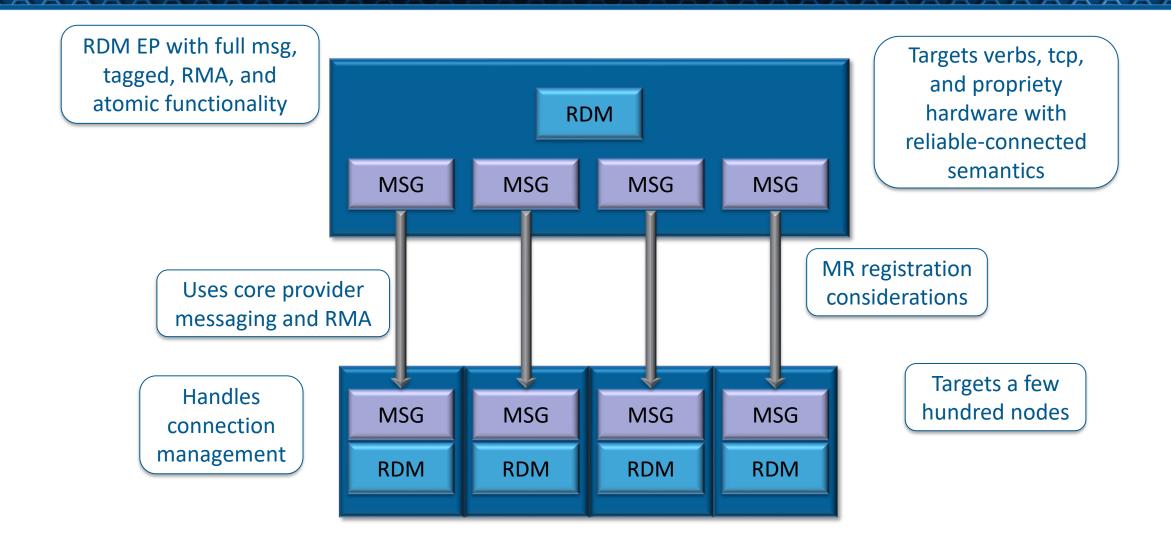
STRUCTURE OVERVIEW





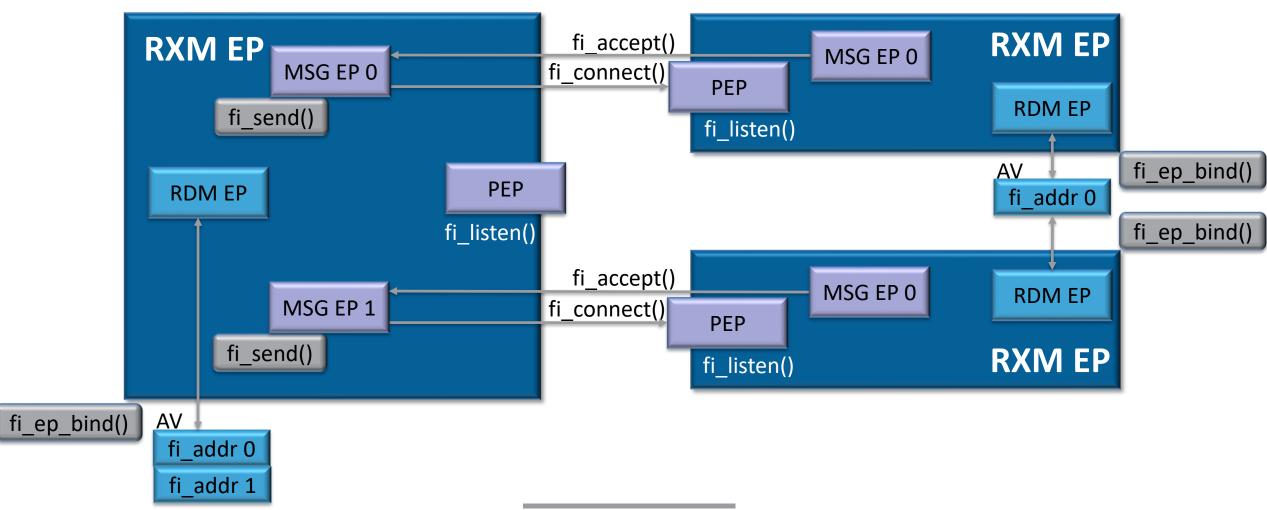


RXM PROVIDER



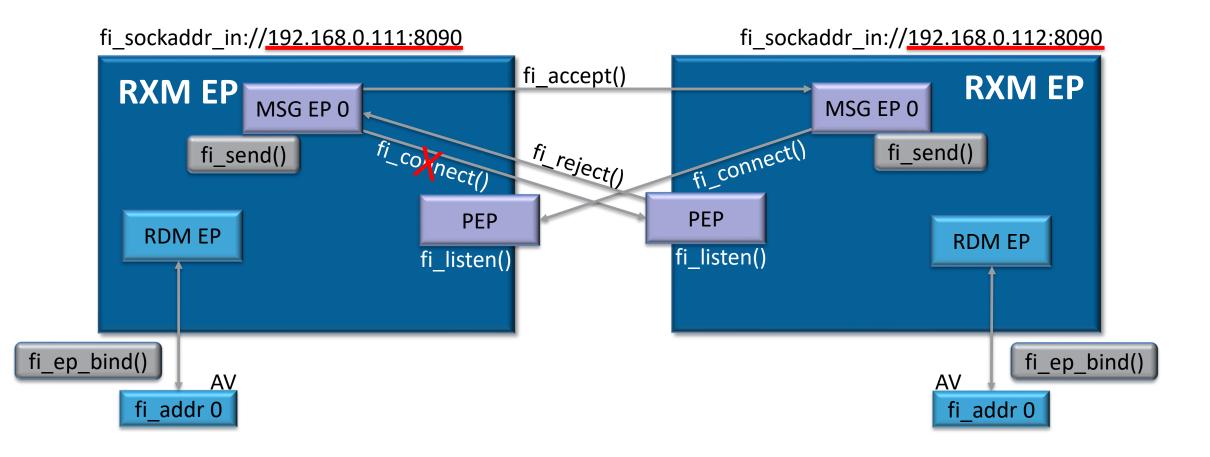
RXM CONNECTION MANAGEMENT

On-demand connections:

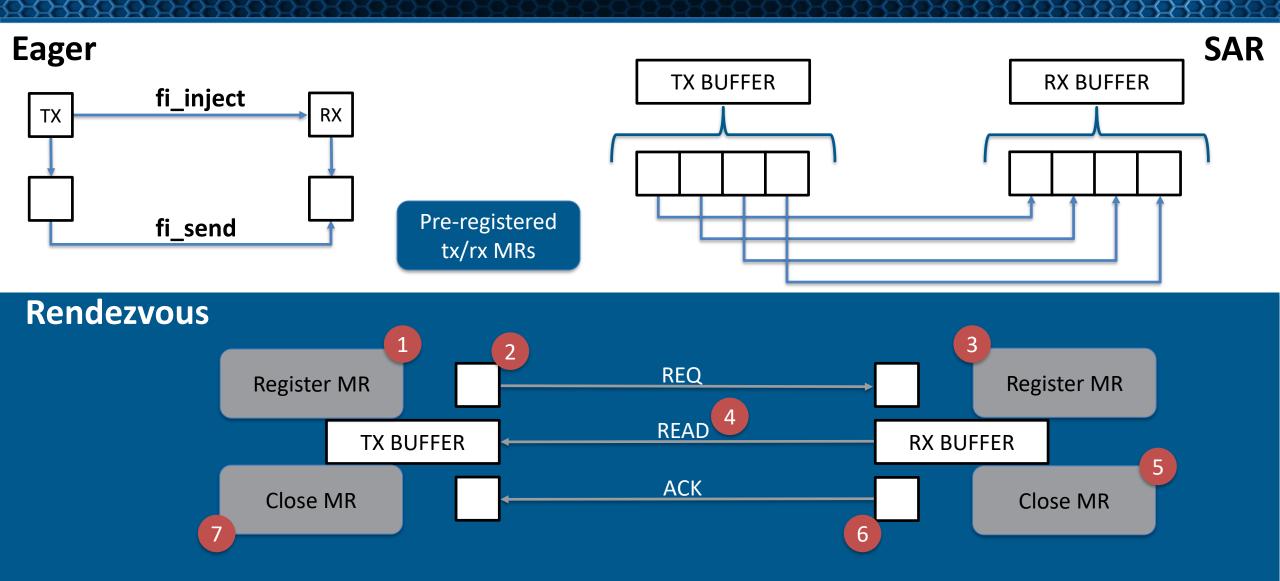


RXM CONNECTION MANAGEMENT

Simultaneous connections:



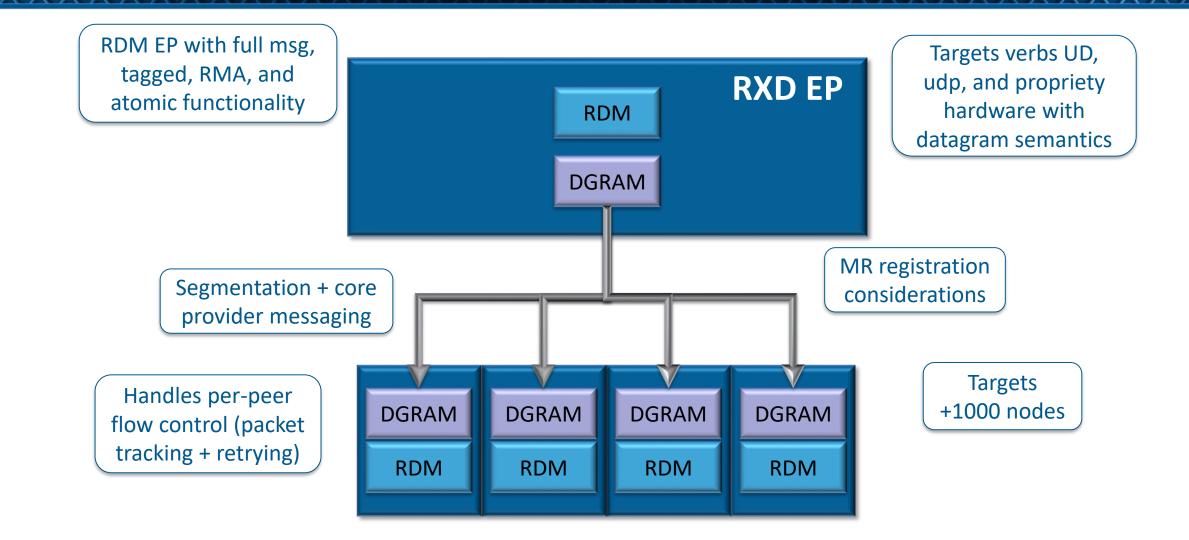
RXM PROTOCOLS



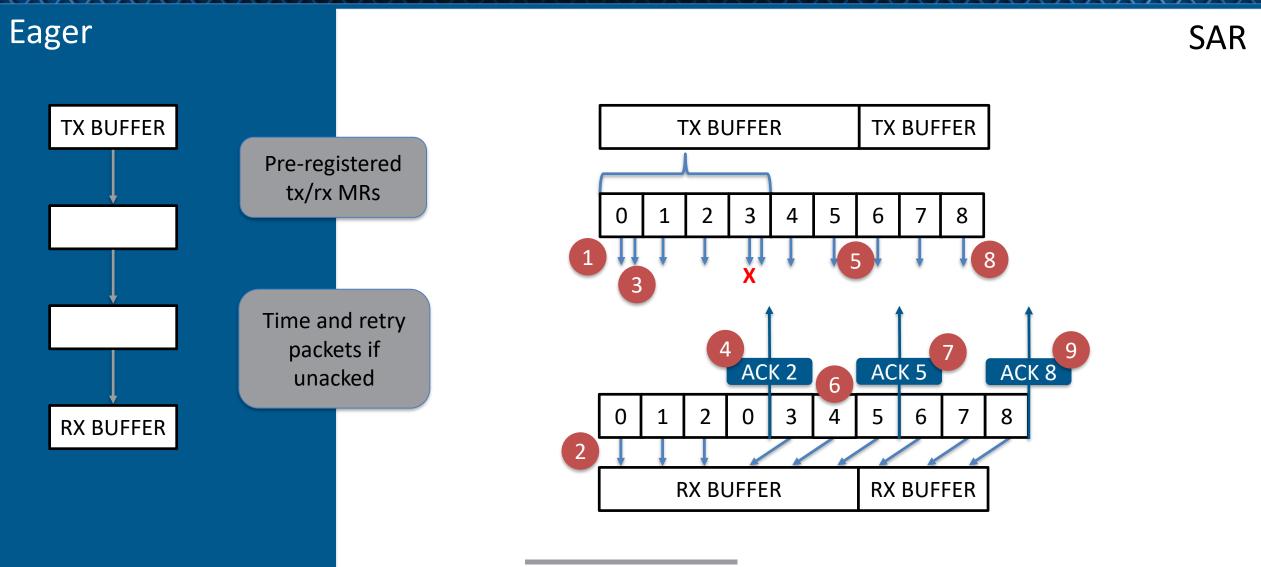




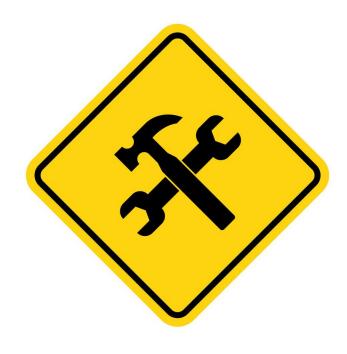
RXD PROVIDER

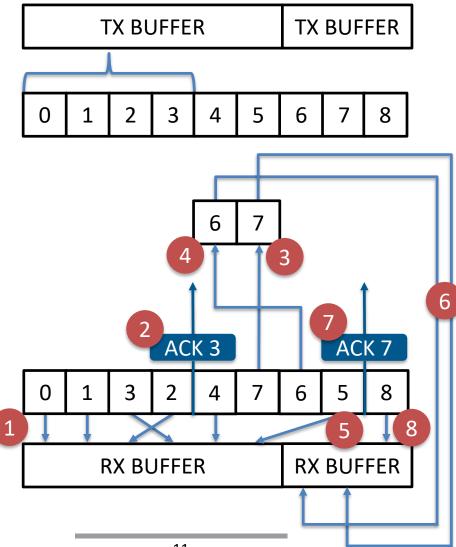


RXD PROTOCOLS



OUT OF ORDER REASSEMBLY



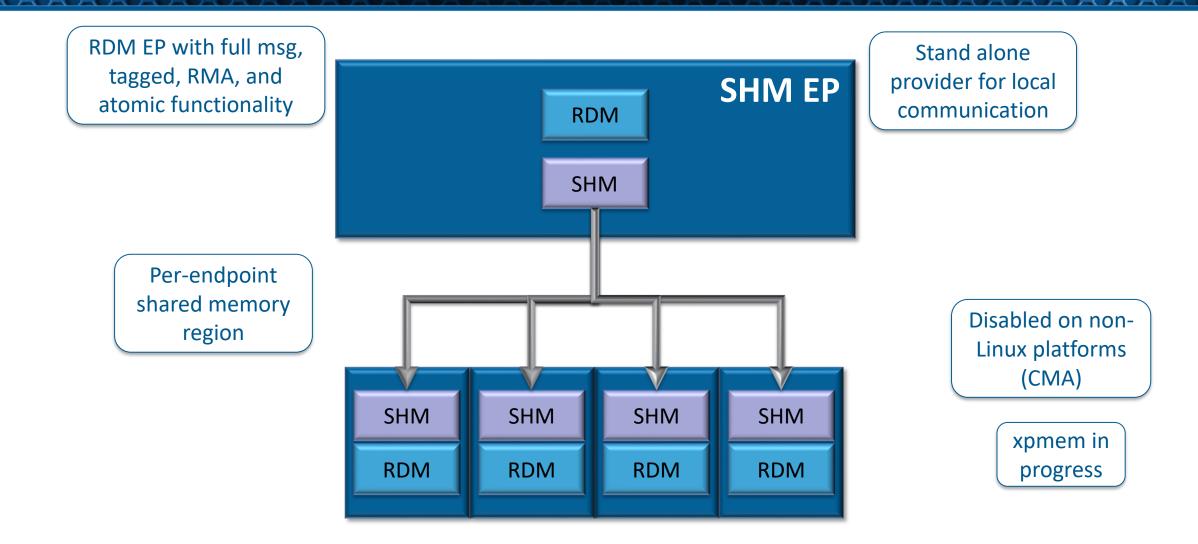


OpenFabrics Alliance Workshop 2019

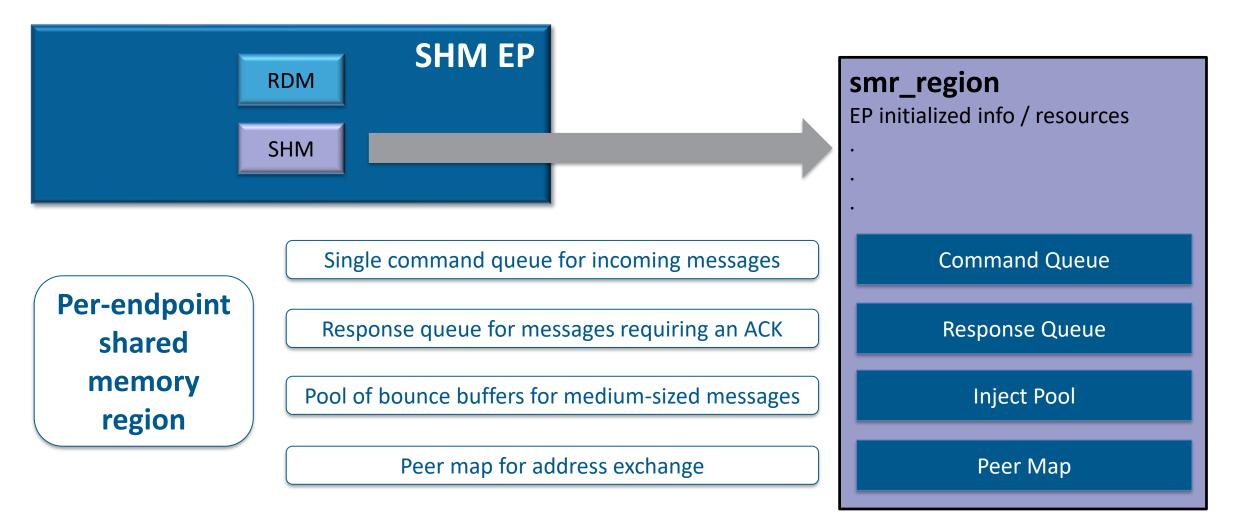




SHM PROVIDER



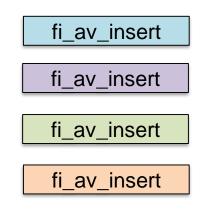
SHARED MEMORY STRUCTURE



SHM ADDRESSING

F	Endpoint name: 11111:0:0				
	0	22222	UNSOPEC		
	1	33333	UNSPEC		
	2	4444	UNSCPEC		
1					

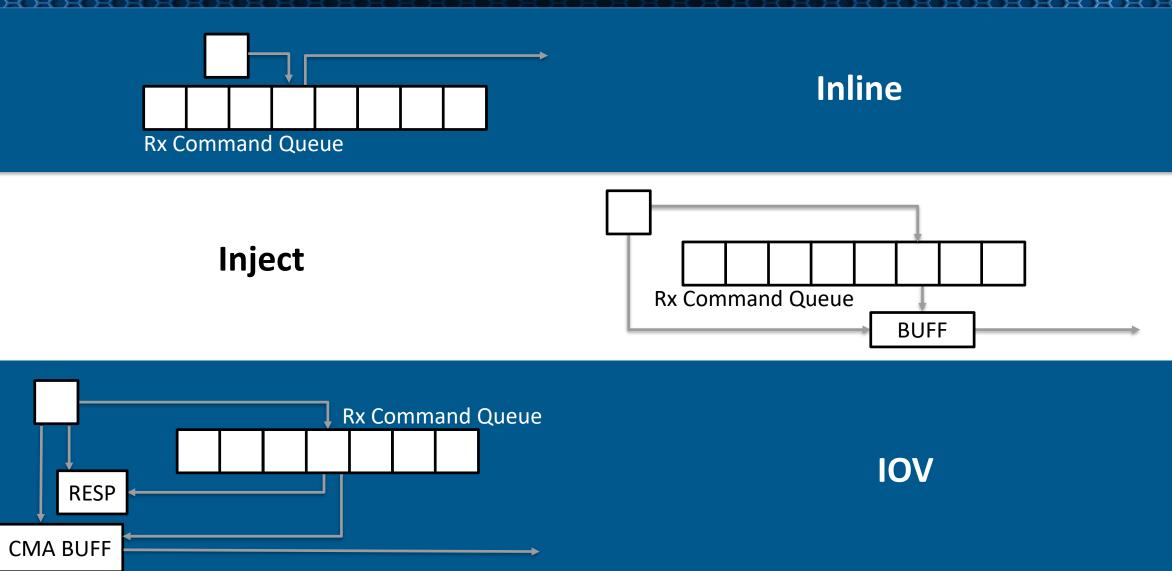
Endpoint name: 33333:0:0					
0	11111	1			
1	22222	UNSIPEC			
2	44444	2			



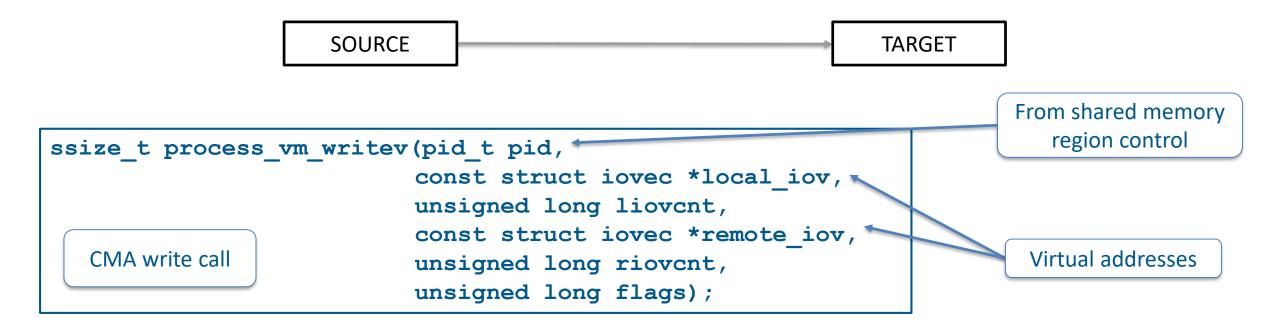
End	Endpoint name: 22222:0:0		
0	11111	0	
1	33333	1	
2	44444	1	

	Endpoint name: 44444:0:0			
Γ				
	0	11111	2	
	1	22222	UNSPEC	
	2	33333	UNSPEC	

SHM PROTOCOLS



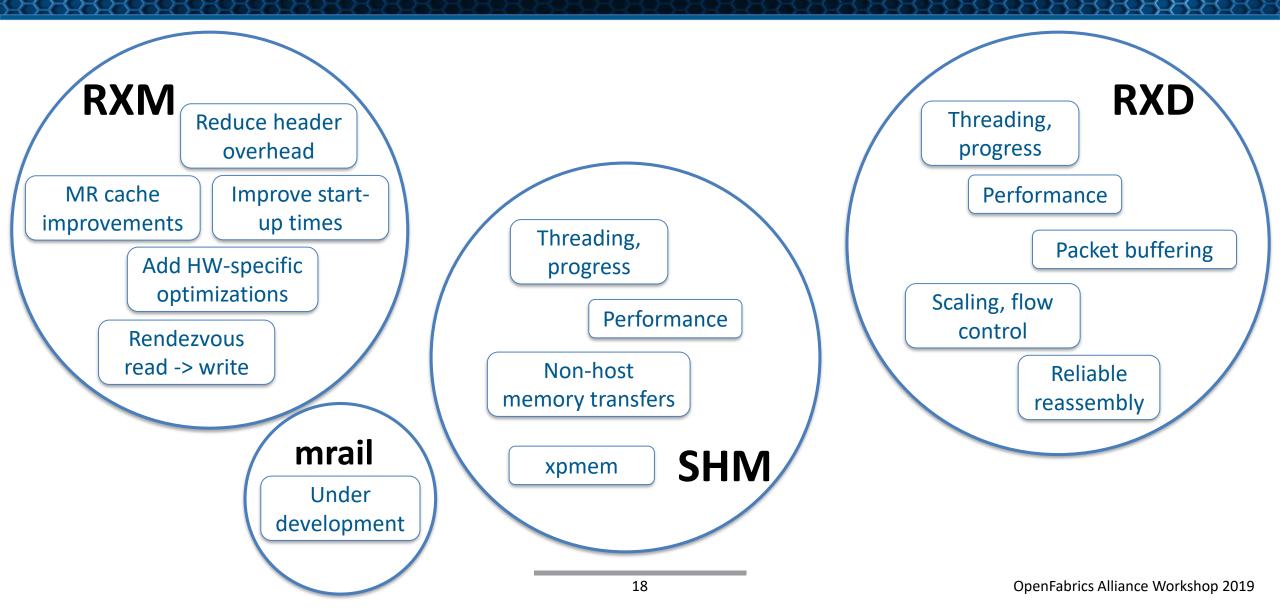
SHM RMA FAST PATH



Requirements for fast path:

- ✓ mr_mode: FI_MR_VIRT_ADDR
- ✓ no RMA ordering requested (RAR, RAW, RAS, WAR, WAW, WAS, SAR, SAW)
- ✓ message is not sending remote CQ data

FUTURE ENHANCEMENTS





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THANK YOU

Alexia Ingerson Intel ® Corporation

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